DMT070WSNHCMU-1E PRODUCT SPECIFICATION

Version 0.1 Feb 22, 2023

TBD

Customer's Approval						
<u>Signature</u> <u>Date</u>						

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Revision History

VERSION	DATE	DESCRIPTION	AUTHOR
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1. General Description

1.1 Introduction

This is a 7.0" size colour active matrix TFT LCD module that uses amorphous silicon TFT as a switching device. The display is normally black mode, transmissive, and featuring high contrast and excellent colour saturation. The resolution of the TFT-LCD is 1024x 600 and can display up to 16.7M colours. The display module supports HDMI interface and tape bonding touch panel.

1.2 Main Features

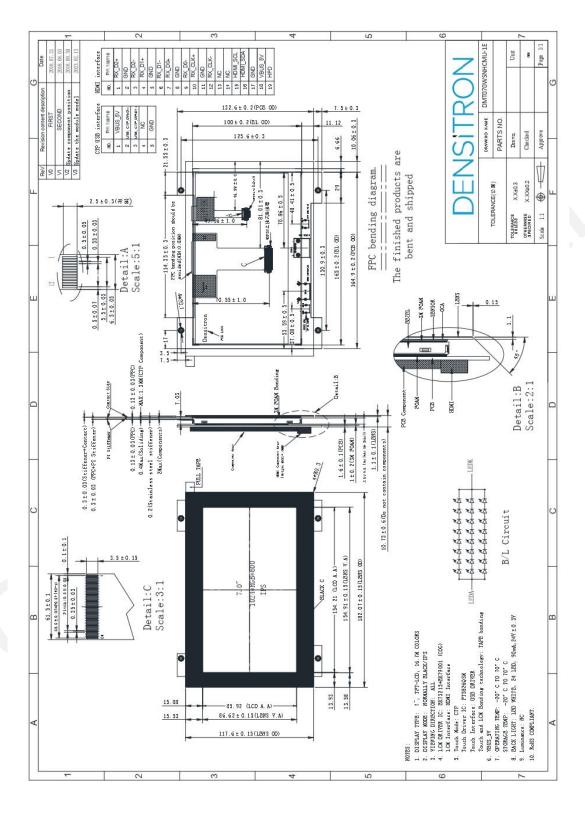
ltem	Contents				
Display Type	TFT LCD				
Screen Size	7.0" Diagonal				
Display Format	1024 x RGB x 600 Dots				
No. of Colour	262K/16.7M				
Overall Dimensions	182.07 (W) x 117.6 (H) x 10.73 (D) mm				
Active Area	154.21 (W) x 85.92 (H) mm				
Mode	Normally Black / Transmissive / IPS				
Surface Treatment	Glare (6H)				
Viewing Direction	All round				
Interface	НДМІ				
Driver IC	EK73215+EK79001				
Touch Panel	СТР				
Touch Interface	USB				
Touch Driver IC	FT5826QSM				
Bonding Type	Tape Bonding				
Operating Temperature	-20°C ~ +70°C				
Storage Temperature	-30°C ~ +80°C				
ROHS	Compliant to RoHS 2.0				

2. Mechanical Specification

2.1 Mechanical Characteristics

Item	Characteristic	Unit		
Display Format	1024 x RGB x 600	Dots		
Overall Dimensions	182.07 (W) x 117.6 (H) x 10.73 (D)	mm		
Active Area	154.21 (W) x 85.92 (H)	mm		
Dot Pitch	0.1506 (W) x 0.1432 (H)	mm		
Weight	TBD	g		
IC Controller/Driver	EK73215+EK79001			

2.2 Mechanical Drawing



Electrical Specification

3.1 Absolute Maximum Ratings

Item	Symbol	Min	Max	Unit	Note
LCM Supply Voltage	VBUS1	-0.3	+5.5	V	Micro 1
CTP Supply Voltage	VBUS2	-0.3	+5.5	V	Micro 2
Operating Temperature	Тор	-20	+70	°C	-
Storage Temperature	T _{ST}	-30	+80	°C	-

Note 1: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. For normal operations, it is desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics", to avoid malfunctioning.

Note 2: Background colour changes slightly depending on ambient temperature. This phenomenon is reversible.

Note 3: Please refer to item of RELIABILITY.

3.2 DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур.	Max	Unit	Note
LCM Supply Voltage	VBUS1	-	4.8	5.0	5.2	V	Micro 1
CTP Supply Voltage	VBUS2	-	4.8	5.0	5.2	V	Micro 2
LCM Normal mode Current	IDD1	-	-	850	-	mA	-
CTP Normal mode Current	IDD1	-	-	20	-	mA	-

3.3 Interface Pin Assignment

3.3.1 HDMI PIN Define

No.	Symbol	I/O	Function			
1	RX_D2+	I	HDMI Receiver channel 2 positive analog input.			
2	GND	Р	Ground.			
3	RX_D2-	I	HDMI Receiver channel 2 negative analog input.			
4	RX_D1+	I	HDMI Receiver channel 1 positive analog input.			
5	GND	Р	Ground.			
6	RX_D1-	I	HDMI Receiver channel 1 negative analog input.			
7	RX_D0+	I	HDMI Receiver channel 0 positive analog input.			
8	GND	Р	Ground.			
9	RX_D0-	I	HDMI Receiver channel 0 negative analog input.			
10	RX_CLK+	I	HDMI Receiver clock positive analog input.			
11	GND	Р	Ground.			
12	RX_CLK-	ı	HDMI Receiver clock negative analog input.			
13	NC		No connection			
14	NC	-	No connection			
15	HDMI_SCL	I	HDMI Receiver DDC data channel.			
16	HDMI_SDA	1/0	HDMI Receiver DDC clock channel.			
17	GND	Р	Ground.			
18	VBUS_5V	Р	HDMI Supply voltage (5.0V).			
19	HPD	0	HDMI Receiver hot plug detect output			

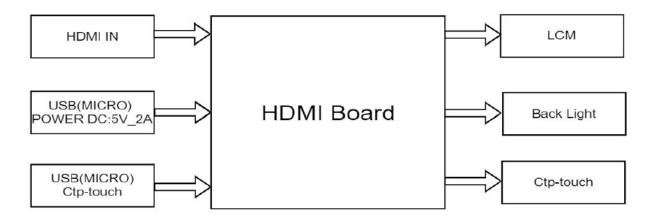
3.3.2 Micro1 USB Power PIN Define

No.	Symbol	I/O	Function				
1	VBUS_5V	Р	LCM Supply voltage (5.0V,2A).				
2	NC	-	No Connection.				
3	NC	-	No Connection.				
4	NC	-	No Connection.				
5	GND	Р	Ground				

3.3.3 Micro2 USB CTP PIN Define

No.	Symbol	I/O	Function				
1	VBUS_5V	Р	CTP Supply voltage (5.0V).				
2	USB_CTP_DN(D-)	1/0	USB data positive analog input.				
3	USB_CTP_DP(D+)	I/O	USB data negative analog input.				
4	NC	-	No Connection.				
5	GND	Р	Ground.				

3.4 Block Diagram

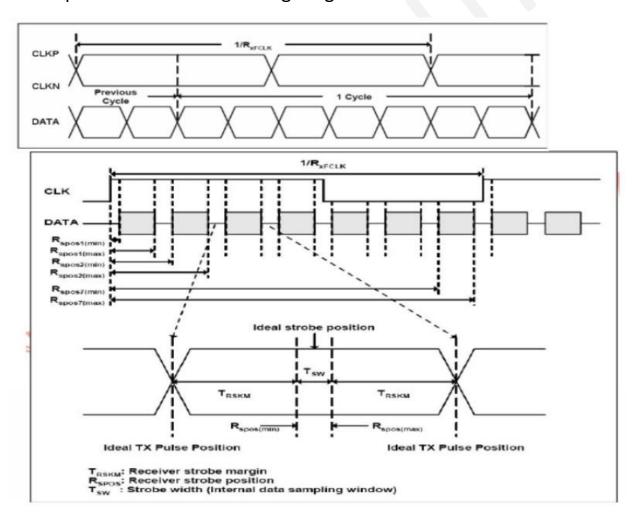


3.5 Timing Characteristics

3.5.1 AC Electrical Characteristics

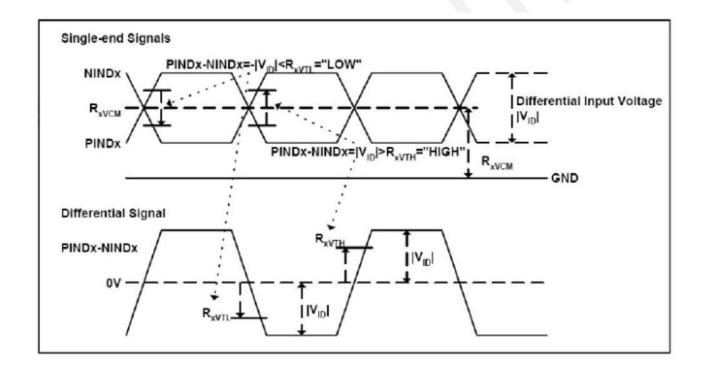
Item	Symbol	Min	Тур.	Max	Unit.
Clock frequency	R _{xFCLK}	40.8	51.2	67.2	MHz
Input data skew margin	Trskm	500	-	-	ps
Clock high time	T _{LVCH}	-	*4/ (7* R _{XFCLK})	-	ns
Clock low time	T _{LVCL}	-	*3/ (7* R _{xFCLK})		ns

3.5.2 Input Clock and Data Timing Diagram



3.5.3 DC Electrical Characteristics

ltem	Symbol	Min	Тур.	Max	Unit.	Note
Differential input high	R _{хVТН}	_	_	+0.1	V	Rxvcm=1.2V
Threshold voltage					-	
Differential input low	D	0.1			V	
Threshold voltage	R _{xVTL}	-0.1	-	-	V	
Input voltage range (single-end)	R _{xVIN}	0	-	2.4	V	
Differential input common mode voltage	R _{xVCM}	V _{ID} /2	-	2.4- V _{ID} /2	V	
Differential voltage	VID	0.2	-	0.6	V	
Differential input leakage current	RV _{xliz}	-10	-	+10	uA	



3.5.4 Timing

ltem	Symbol	Min	Тур.	Max	Unit.	Note
Clock Frequency	fclk	40.8	51.2	67.2	MHz	Frame rate=60Hz
Horizontal display area	thd		1024		DCLK	
HS period time	th	1114	1344	1400	DCLK	
HS Blanking	thb	90	320	376	DCLK	
Vertical display area	tvd		600		Н	
VS period time	tv	610	635	800	Н	
VS Blanking	thb	10	35	200	Н	

4. Electrical Specification Touch

4.1 Electrical Characteristics

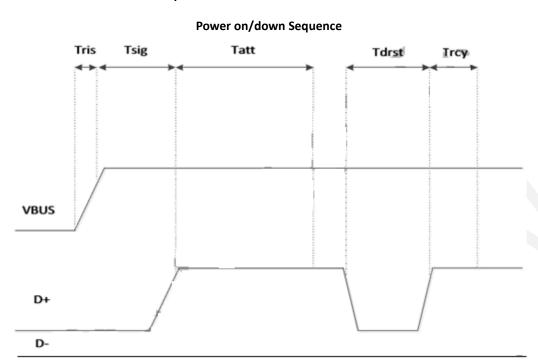
4.1.1 Absolute Maximum Rating

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Power Supply Voltage	VBUS_5V	-0.3	-	5.5	V	1, 2
Operating Temperature	Тор	-20	-	+70	$^{\circ}$ C	1
Storage Temperature	Tst	-30	-	+80	$^{\circ}$ C	1

4.1.2 Power Consumption

IC	Interface	Active (mA)	Monitor (mA)	Sleep (uA)
	I2C	19.16	9.88	35.4
FT5C26	I2C-HID	19.02	9.66	188.5
	USB-HID	20.73	10.27	187.5
	I2C	17.20	8.63	35.4
FT5B26	I2C-HID	17.21	8.67	188.5
	USB-HID	18.77	9.48	187.5
	I2C	15.12	7.77	35.4
FT5926	I2C-HID	15.01	7.58	188.5
	USB-HID	16.68	8.56	187.5
	I2C	12.97	6.85	35.4
FT5826	I2C-HID	12.91	6.78	188.5
	USB-HID	14.55	7.44	187.5

4.1.3 Power On/Reset Sequence



USB Power on/Reset Sequence Items

Item	Description	Min	Max	Unit
Tris	Rise time from 0.1VDD to 0.9VDD	-	5	ms
Tsig	Time required for the device internal power rail to stabilize and for D+ or D- to reach VIH (min)	100	-	ms
Tatt	Time ensures that the electrical and mechanical connection is stable before software attempts to reset the attached device.	100	-	ms
Tdrst	Time hubs drive reset to a device	10	-	ms
Trcy	The USB System Software guarantees a minimum of 10ms for reset recovery	10	-	ms

4.1.4 USB

USB is configured in device mode, and a Full speed USB function is supported. The USB function controller is as follows.

- USB 2.01-compliant composite device, full speed (12Mbps)
- Require external crystal (12MHz)
- Support USB LPM L1
- Integrated transceive.
- Support USB-HID protocol for Win8.
- Vendor ID: 0x2808

5. Optical Specification

5.1 Optical Characteristics

Chara	cteristics	Symbol	Conditions	Min	Тур.	Max	Unit	Note
Contra	ast Ratio	CR	0. 00	600	800	-	-	1
Respo	nse time	Rising Falling	$\theta = 0^{\circ}$ Normal	-	25	40	msec	2
Color	Gamut	S (%)	viewing angle	45	50	-	%	-
9 <u>8</u>	Left	θ _x -		-	85	-		
Viewing Angle	Right	Өх+	CD \ 10	-	85	-		
wing	Up	θ _Y +	CR>10	-	85	-		-
Vie	Down	Өү-		-	85	-		
	Dl	Rx		0.5668	0.5868	0.6068		
	Red	Ry		0.3305	0.3505	0.3705	-	
icity	_	Gx		0.2880	0.3080	0.3280	_	
Colour Chromaticity	Green	Gy	θ = 0°	0.5230	0.5430	0.5630		
ır Chr	D.	Вх	Normal viewing angle	0.1338	0.1538	0.1738		-
Color	Blue	Ву	viewing ungle	0.0738	0.0938	0.1138		
		Wx		0.2477	0.2877	0.3277		
	White	Wy		0.2672	0.3072	0.3472		
Lum	inance	Lv	_	550	600	-	cd/m ²	-
Unif	ormity	Avg	-	TBD	-	-	%	-

Measuring Condition: in dark room, at ambient temperature = 25±2°C, 15 min. warm-up time

Note	Item	Test method
1	Definition of Viewing Angle	Normal line $\theta = \Phi = 0^{\circ}$ $\Phi = 90^{\circ}$ 12 o'clock direction $\Phi = 270^{\circ}$ 6 o'clock direction
2	Definition of Contrast Ratio (CR)	Measured at the center point of panel Contrast ratio (CR) = Luminance measured when LCD is at "white state" Luminance measured when LCD is at "black state"
3	Definition of Response Time (T _R , T _F)	Display data Black (TFT OFF) White (TFT ON) Black (TFT OFF) Optical Response 10% 0%
4	Definition of Optical Measurement Setup	Photo-detector (BM-5A) 50cm Center of panel LCD panel

6. Packaging

TBD

7. Quality Assurance Specification

7.1 Conformity

The performance, function and reliability of the shipped products conform to the Product Specification.

7.2 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature: $25 \pm 5^{\circ}$ C

Humidity: $65\% \pm 10\% \text{ RH}$

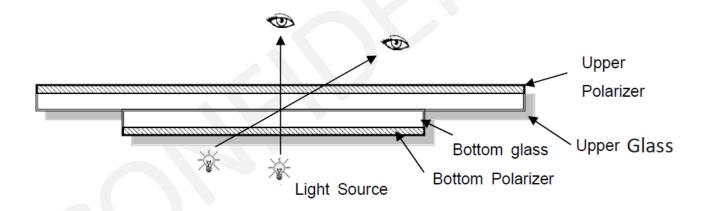
Viewing Angle: Normal Viewing Angle

Illumination: Single fluorescent lamp (300 to 700 Lux)

Viewing distance: 30 - 50cm

Finger glove (or finger cover) must be worn by the inspector.

Inspection table or jig must be anti-electrostatic.

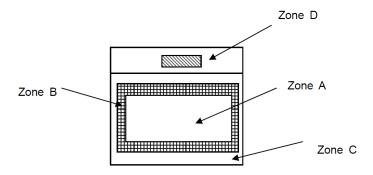


7.3 Delivery Assurance

7.3.1 Delivery Inspection Standards

Class II, Normal Inspection, MIL-STD-105E

7.3.2 Zone Definition



Zone A: Effective Viewing Area (Character or Digit can be seen)

Zone B: Viewing Area except Zone A

Zone C: Outside (Zone A + Zone B) Area which cannot be seen after assembly by customer.

Zone D: IC Bonding Area

Note: Generally, visual defects in Zone C can be ignored when it doesn't affect product function or appearance after assembly by customer

7.3.3 Criteria & Acceptable Quality Level

Partition	AQL Definition	
Major	0.65	Defects in Pattern Check (Display On)
Minor	Minor 1.5 Defects in Cosmetic Check (Display Off)	

LCD: Liquid Crystal Display, TP: Touch Panel, LCM: Liquid Crystal Module

No.	Items	Criteria	Classification of defects
1	1) No display, open or miss line 2) Display abnormally 3) Backlight no lighting, abnormal lighting. 4) TP no function		Major
2	Missing		
3	Outline dimension Overall outline dimension beyond the drawing is not allowed		
4	Color tone	Color unevenness, refer to limited sample	
5	Spot Line Defect Light dot, Dim spot, Polarizer Bubble; Polarizer accidented spot.		Minor
6	Soldering Appearance Good soldering, peeling off is not allowed.		
7	LCD/Polarizer/CTP Black/White spot/line, scratch, crack, etc.		

7.3.4 Criteria & Classification

Units: mm

Class	Item		Criteria				
		Round type: as per fo	ollowing drawing, \emptyset = (X+Y)/2	X	_		
		1) Light Dot (LCD/T	P/Polarizer black/white spot, pi	inhole, stain, e	etc.)		
		_	Acceptable	e Quantity			
		Size\Zone	Α	В	С		
	Ø≤0.10	Ignore					
	0.10<∅≤0.25	3 (distance ≥ 10mm	1)				
		0.25<∅≤0.4	2 (distance ≥ 10mm	1)	Ignore		
	0.4<Ø	0					
		2) Dim Spot (LCD/TP/Polarizer dim dot, light leakage, dark spot, etc.)					
		Size\Zone	Acceptable	Acceptable Quantity			
	Size (zone	Α	В	С			
∕linor	Spot Defect	Ø≤0.15	Ignore				
-		0.15<∅≤0.25	3 (distance ≥ 10mm)		Ignore		
		0.25<∅≤0.4	2 (distance \geq 10mm)		ignore		
		0.4<∅	0				
		3) Polarizer Accide	nted Spot				
		Size\Zone —	Acceptable	e Quantity			
		Size (Zone	Α	В	С		
		Ø≤ 0 .2	Ignore				
		0.2<∅≤0.5	2 (distance ≥ 10mm	1)	Ignore		
		0.5<∅	0				
	4) Pixel Bad Points	(light dot, Dim dot, color dot)					
	Item	Zone A	Acce	eptable Qt			
			Random		N≤2		
		Bright dot	2 dots adjacent		N≤0		
			3 dots adjacent		N≤0		
		Dark dot	Random		N≤3		

Class	ltem		Criteria			
			2 dots adjacent		N≤0	
			3 dots adjacent		N≤0	
			1. Minimum Distance			
			Between Bright dots.			
			2. Minimum Distance			
		Distance	Between dark dots		5mm	
			3. Minimum Distance			
			Between dark and bright dot.			
		Total bright and dark dot N≤4				
		Note:	te ann agu buight and mahanga d i	a aina ia vulsiala	ICD manalia	
			ts appear bright and unchanged in	n size in which	LCD panel is	
		displaying under b		- i bi-b I CD		
			appear dark and unchanged in size	e in which LCD	panei is	
			ure red, green, blue picture.			
		C) 2 dot adjacent =	= 1 pair = 2 dots			
		Picture:				
				ľ		
		2 dot adjace	ent 2 dot adj	acent		
		2 dot adjacent	(vertical) 2 dot adja	acent (slant)		
		5) Polarizer Bubb	ple			
		Size\Zone	Acceptabl	e Quantity		
		3126 (20116	Α	В	С	
		Ø≤0.2	Ignore			
		0.2<∅≤0.4	2 (distance ≥ 10mn	n)	Ignore	
		0.4<Ø	0			
Minor	Line Defect (LCD/TP/ Polarizer	Line type: as per fo	ollowing drawing	W //•		
	backlight		L			

Class	Item		Criteria			
	black/white line,	we lil	Accepta		able quar	ntity
	scratch, stain)	Width	Length	А	В	С
		W≤0.05	Ignore	Ignore	9	
		0.05 <w≤0.06< td=""><td>L ≤ 5.0</td><td>N ≤ 3</td><td></td><td>Ignore</td></w≤0.06<>	L ≤ 5.0	N ≤ 3		Ignore
		0.06 <w≤0.08< td=""><td>L ≤ 4.0</td><td>N ≤ 2</td><td></td><td></td></w≤0.08<>	L ≤ 4.0	N ≤ 2		
		0.08 <w< td=""><td>Define as s</td><td>pot defect</td><td></td><td></td></w<>	Define as s	pot defect		
Minor	LCD Crack/Broken	Symbols: X: Length, Y: Width, Z: Height, L: Length of ITO, T: Height of LCD 1) The edge of LCD broken: X≤3.0mm; Y <inner 2)="" border="" broken:="" corner="" lcd="" line="" of="" seal;="" td="" the="" x≤3.0mm;="" y≤l;="" z≤t="" z≤t<=""></inner>				
Major	LCD Crack	The LCD with exter	nsive crack is not acceptable.			
Major	Electronic Components SMT		parts, solderless connection, cold ive polarity opposite	solder joint, n	nismatch,	, The

Class	ltem	Criteria
Minor	Display colour & Brightness	 Colour: Measuring the colour coordinates in accordance with the datasheet or samples. Brightness: Measuring the brightness of white screen in accordance with the datasheet or samples.
	LCD Mura	By 5% ND filter invisible.

Class	ltem	Criteria					
	CTP Related	CTP Cover Sensor Accidented Black/White Spot					
		Size\Zone	Acceptable Qty				
			Α		В	С	
		Ø≤0.15		Ignore			
		0.15<∅≤0.25	4 (distance≥10mm)			Ignore	
		0.25<∅≤0.35	3 (distance≥10mm)		1)	ignore	
		0.35<∅		1			
		2) CTP Cover Scra	2) CTP Cover Scratch				
		Width	Length		Acceptable Qty		
		Width		Α	В	С	
		Ф≤0.05	Ignore	Ignore			
		0.05 <w≤0.06< td=""><td>L≤4.0</td><td colspan="3">N≤3</td></w≤0.06<>	L≤4.0	N≤3			
Minor		0.06 <w≤0.08< td=""><td>L≤3.0</td><td colspan="3">N≤2</td></w≤0.08<>	L≤3.0	N≤2			
		0.08 <w< td=""><td colspan="4">Define as spot defect</td></w<>	Define as spot defect				
		3) CTP Cover Pinhole / Lack of Ink					
		Size\Zone	Acceptable Qty				
			С				
		Ø≤0.2	Ignore				
		0.2<∅≤0.3	4 (distance≥10mm)				
		0.3<∅≤0.4	2 (distance≥10mm)				
		0.4<Ø	O				
		4) CTP Bonding Bubble / Accidented Spot					
		Size\Zone	Acceptable Qty			D.	
		Ø≤0.1	A B				
		0.1<∅≤0.2	Ignore 3 (distance ≥ 10mm)				
		0.1<∀∑0.2	3 (uistance≤ 10mm)				

Class	Item	Criteria			
		0.2<∅≤0.3	2 (distance≥10mm)		
		0.3<∅	0		
		Assembly Deflection	on: beyond the edge of backlight ≤0.2mm		
Minor	CTP Related		: length, Y: width, Z: height m; Z <cover allowed.<="" is="" not="" td="" thickness=""></cover>		
			: length, Y: width, Z: height m; Z <lcd allowed.<="" is="" not="" td="" thickness=""></lcd>		

Criteria (functional items)

No.	Item	Criteria
1	No display	
2	Missing segment	
3	Short circuit	Not allowed
4	Backlight no lighting	
5	CTP no function	

7.4 Dealing with Customer Complaints

7.4.1 Non-conforming Analysis

Purchaser should supply Densitron with detailed data of non-conforming sample.

7.4.2 Handling of Non-conforming Displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

8. Reliability Specification

8.1 Reliability Tests

Test Item	Test Condition	Inspection after Test	
High Temperature Operating	70℃,96H		
Low Temperature Operating	-20°℃, 96HR	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects: 1.Air bubble in the LCD; 2.Non-display;	
High Temperature Storage	80°C,96HR		
Low Temperature Storage	-30°C,96HR		
Thermal Shock (Non-operation)	-10°C,30 min ↔ +60°C,30 min,		
mermai snock (Non-operation)	Change time:5min 20CYC.		
	C=150pF, R=330,5points/panel		
ESD Test	Air: ±8KV, 5times; Contact: ±6KV, 5 times;		
	(Environment: 15° C ~ 35° C, 30% ~ 60%).	3.Missing segments/line;	
	Frequency range:10~55Hz, Stroke:1.5mm	4.Glass crack;	
Vibration (Non-operation)	Sweep:10Hz~55Hz~10Hz 2 hours for each direction of	5.Current IDD is twice	
	X.Y.Z. (6 hours for total) (Package condition).	higher than initial value.	
Box Drop Test	1 Corner 3 Edges 6 faces,80 cm (MEDIUM BOX)		

Note 1: The test samples should be applied to only one test item.

Note 2: Sample size for each test item is 5~10pcs.

Note 3: For Damp Proof Test, Pure water(Resistance > 10M Ω) should be used.

Note 4: In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

Note 5: Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

Note 6: The color fading mura of polarizing filter should not care.

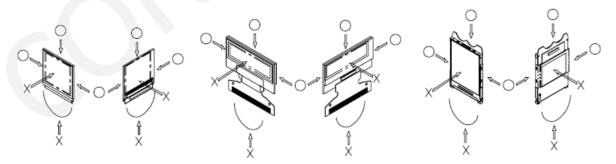
8.1.1 Inspection Check Standard

After the completion of the described reliability test, the samples are to be left at room temperature for 4 hrs prior to conducting the inspection check at 25 ± 5 °C, $65\pm10\%$ RH.

Handling Precautions

9.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water
- 4) If pressure is applied to the display surface or its neighbourhood of the display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 5) The polarizer covering the surface of the display module is soft and easily scratched. Please be careful when handling the display module.
- 6) When the surface of the polarizer of the display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - a. Scotch Mending Tape No. 810 or an equivalent
 - b. Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.
 - c. Also, pay attention that the following liquid and solvent may spoil the polarizer:
 - Water
 - Ketone
 - Aromatic Solvents
- 7) Hold the display module very carefully when placing it into the system housing. Do not apply excessive stress or pressure to display module. And, do not over bend the film with electrode pattern layouts. These stresses will



influence the display performance. Also, secure sufficient rigidity for the outer cases.

- 8) Do not apply stress to the LSI chips and the surrounding molded sections.
- 9) Do not disassemble nor modify the display module.
- 10) Do not apply input signals while the logic power is off.
- 11) Pay sufficient attention to the working environments when handing display modules to prevent occurrence of element breakage accidents by static electricity.

- a. Be sure to make human body grounding when handling display modules.
- b. Be sure to ground tools to use or assembly such as soldering irons.
- c. To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- d. Protective film is being applied to the surface of the display panel of the display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 12) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. If the display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 13) If electric current is applied when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

9.2 Storage Precautions

- 1) When storing display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you store these modules in the packaged state when they were shipped from Densitron) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the display module, when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

9.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighbouring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the display module, fasten the external plastic housing section.
- 7) If power supply to the display module is forcibly shut down by such errors as taking out the main battery while the display panel is in operation, we cannot guarantee the quality of this display module.

9.4 Operation Precautions

- 1) It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.
- 2) Direct current causes an electrochemical reaction with remarkable deterioration of the display quality. Give careful consideration to prevent direct current during ON/OFF timing and during operation.
- 3) Response time is extremely delayed at temperatures lower than the operating temperature range while, at high temperatures, displays become dark. However, this phenomenon is reversible and does not mean a malfunction or a display that has been permanently damaged.
- 4) To protect display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the display modules.
 - a. Pins and electrodes
 - b. Pattern layouts such as the FPC
- 5) When the driver is being exposed (COG), semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if the driver is exposed to light, malfunctioning may occur.
 - a. Design the product and installation method so that the driver may be shielded from light in actual usage.
 - b. Design the product and installation method so that the driver may be shielded from light during the inspection processes.
- 6) Although the display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 7) We recommend you construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

9.5 Other Precautions

1) Request the qualified companies to handle industrial wastes when disposing of the display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.